

CERAMIC RESONATOR SPECIFICATION

1. SCOPE

This specification shall cover the characteristics of the ceramic resonator with 4.00 MHz for the clock oscillation of microprocessor etc.

2. SPECIFICATION NO :

3. FACTORY NO : ZTT 4.00 MG

4. ELECTRICAL SPECIFICATION

4.1 Oscillation Frequency (Fosc) : 4.00 MHz \pm 0.3%

4.2 Resonant Impedance (Ro) : 30 Ω

4.3 Temperature Coefficient of Oscillation Frequency : \pm 0.3% max. (-20°C to +80°C)

4.4 Withstanding Voltage : 100 VDC 5 sec.max.

4.5 Reting Voltage

(1) D.C. Voltage : 6 V.D.C.

(2) A.C. Voltage : 15 Vpp.

4.6 Insulation Resistance : 100M Ω min. (at 10 VDC)

4.7 Operation Temperature : -20°C to +80°C

4.8 Storage Temperature : -55°C to +80°C

4.9 Aging Rate (Fosc) : \pm 0.3% max. (10 years)

5. MEASUREMENT

5.1 Measurement Condition

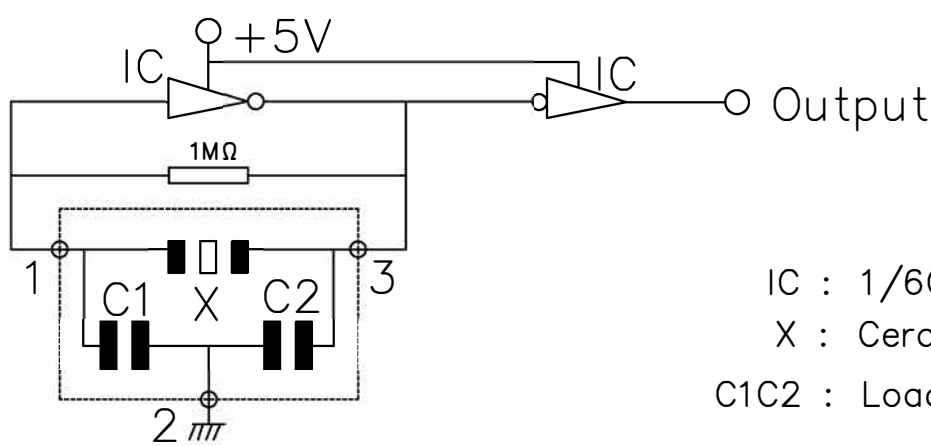
The reference temperature shall be 25°C \pm 2°C . The measurement shall be performed at the temperature range of 5°C to 35°C unless otherwise the result is doubtful.

5.2 Measurement Circuit and Equipment

Oscillating frequency shall be measured by the standard test circuit as shown in Fig. 1.

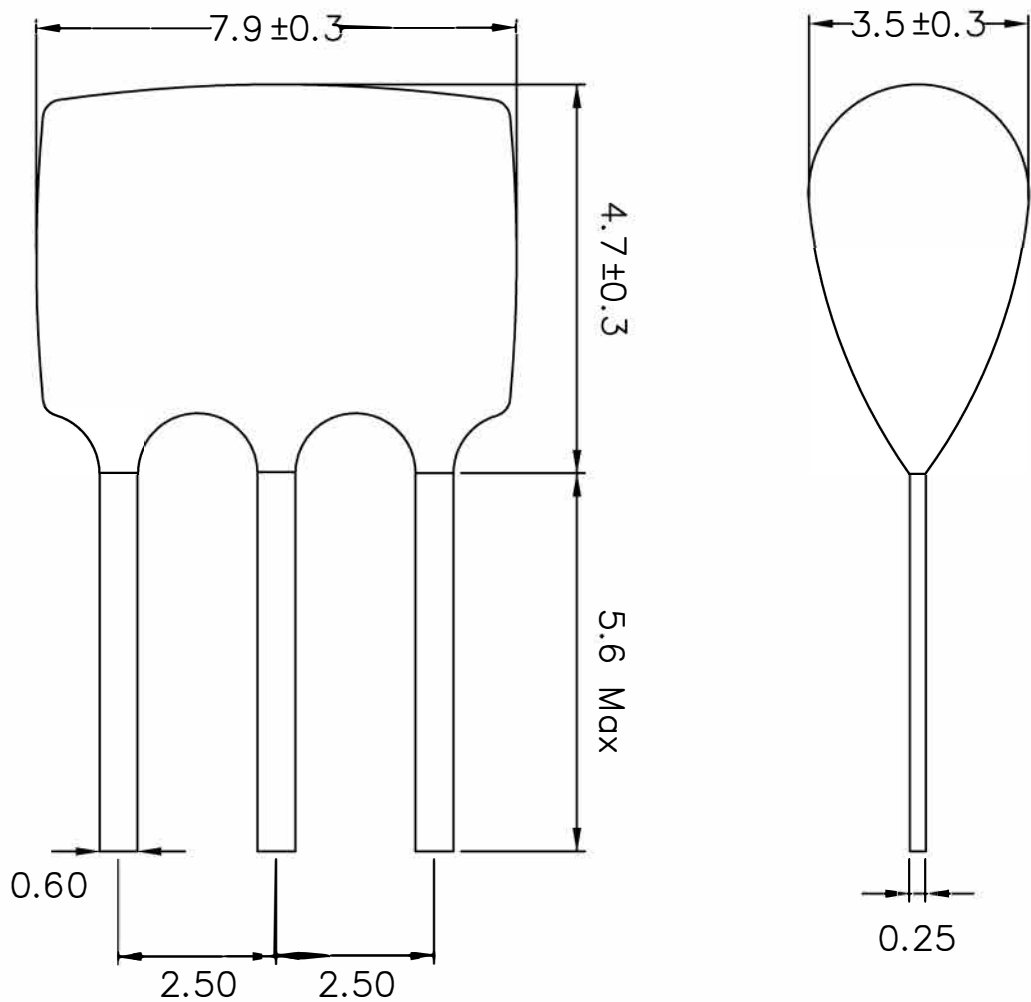
Resonant impedance shall be measured by HP8751A Network Analyzer

5.2 TEST CIRCUIT



IC : 1/6CD4069UBE X 2
X : Ceramic Resonator
C1C2 : Load Capacftance

6.0 DIMENSIONS



FREQUENCY	ENGINEER	HOLDER TYPE	RESONATOR ZTT4.00MHZ	
		DIMENSION	mm	
		SCALE	8 : 1	

7. PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

NO	ITEM	CONDITION OF TEST	PERFORMANCE REQUIREMENTS
7.1	Humidity	Keep the resonator at 40 ± 2 and 90-95% RH for 96 hours. Then release the resonator into the room condition for 1 hour prior to the measurement.]	It shall fulfill the specifications in Table 1.
7.2	Vibration	Subject the resonator to vibration for 2 hours each in x.y and z axis with the amplitude of 1.5 mm, the frequency shall be varied uniformly between the limits of 10-55Hz	It shall fulfill the specifications in Table 1.
7.3	Mechanical Shock	Drop the resonator randomly onto a concrete floor from the height of 70 cm 3 times.	It shall fulfill the specifications in Table 1. and 4.2.
7.4	Resistance to Solder Heat	Dip the resonator terminals no closer than 2 mm into the solder bath 260 ± 10 for 3 ± 0.5 sec.	It shall fulfill the specifications in Table 1.
7.5	Solder ability	Dip the resonator terminals on closer than 2mm into the solder bath at 235 ± 5 for 3 ± 0.5 sec.	More than 95% of the terminal surface of the resonator shall be covered with fresh solder.
7.6	High Temperature Exposure	Subject the resonator to 80 ± 5 for 96 hours. Then release the resonator into the room conditions for 1 hours prior to the measurement.	It shall fulfill the specifications in Table 1.
7.7	Low Temperature	Subject the resonator to -20 ± 5 for 96 hours. Then release the resonator into the room conditions for 1 hour prior to the measurement.	It shall fulfill the specifications in Table 1.
7.8	Temperature Cycling	Subject the resonator to -20 for 30 min. followed by a high temperature of $+80$ for 30 min. Cycling shall be repeated 5 times with a transfer time of 15 sec. at the room condition. Then release the resonator into the room temperature for 1 hour prior to the	It shall fulfill the specifications in Table 1.

7. PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

(Continued from the preceding page)

COST A LOT OF MONEY

NO	ITEM	CONDITION OF TEST	PERFORMANCE REQUIREMENTS
7.9	Lead Fatigue (1) Pulling Test	Weight along with the direction of terminals without any shock 0.5 kg for 10 ±1 sec.	The resonator shall show no evidence of damage and shall fulfill all the initial electric characteristics.
	(2) Bending Test	Lead shall be subject to withstand 90 degree bending at its stem. This operation shall be done towards both direction.	

TABLE 1

ITEM	SPECIFICATION
Oscillation Frequency Change	$F/F_{ose} < 0.3\% \text{ max}$
Resonant Impedance	$R_o < 5\Omega$

8. REVIEW OF SPECIFICATIONS

When something get doubtful with this specifications, we shall jointly work to get an agreement.